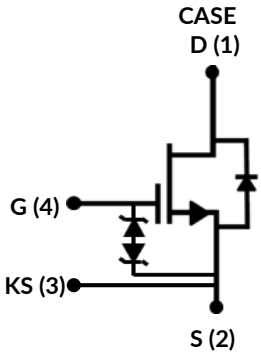
UnitedSiC

Related Devices | Buy Online | Spice Models | Contact Sales | Learn More

DATASHEET

UF3C065080K4S



Part Number	Package	Marking
UF3C065080K4S	TO-247-4L	UF3C065080K4S

650V-80mΩ SiC Cascode

Rev. A, January 2019

Description

United Silicon Carbide's cascode products co-package its high-performance F3 SiC fast JFETs with a cascode optimized MOSFET to produce the only standard gate drive SiC device in the market today. This series exhibits very fast switching using a 4-terminal TO-247-package and the best reverse recovery characteristics of any device of similar ratings. These devices are excellent for switching inductive loads, and any application requiring standard gate drive.

Features

- Typical on-resistance $R_{DS(on),typ}$ of 80mΩ
- Maximum operating temperature of 175°C
- Excellent reverse recovery
- Low gate charge
- Low intrinsic capacitance
- ESD protected, HBM class 2
- TO-247-4L package for faster switching, clean gate waveforms

Typical applications

- EV charging
- PV inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Experts on Design-In
Angst+Pfister Sensors and Power

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V_{DS}		650	V
Gate-source voltage	V_{GS}	DC	-25 to +25	V
Continuous drain current [1]	I_D	T_C = 25°C	31	A
		T_C = 100°C	23	A
Pulsed drain current [2]	I_{DM}	T_C = 25°C	65	A
Single pulsed avalanche energy [3]	E_{AS}	L=15mH, I_{AS} =2.1A	33	mJ
Power dissipation	P_{tot}	T_C = 25°C	190	W
Maximum junction temperature	$T_{J,max}$		175	°C
Operating and storage temperature	T_J, T_{STG}		-55 to 175	°C
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T_L		250	°C

1. Limited by $T_{J,max}$
2. Pulse width t_p limited by $T_{J,max}$
3. Starting T_J = 25°C

Thermal Characteristics

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.61	0.79	°C/W

Experts on Design-In
Angst+Pfister Sensors and Power

UnitedSiC
Related Devices Buy Online Spice Models Contact Sales Learn More

Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Drain-source breakdown voltage	BV_{DS}	V_{GS}=0V, I_D=1mA	650			V
Total drain leakage current	I_{DSS}	V_{DS}=650V, V_{GS}=0V, T_J=25°C		6	100	µA
		V_{DS}=650V, V_{GS}=0V, T_J=175°C		40		
Total gate leakage current	I_{GSS}	V_{DS}=0V, T_J=25°C, V_{GS}=-20V / +20V		6	±20	µA
Drain-source on-resistance	$R_{DS(on)}$	V_{GS}=12V, I_D=20A, T_J=25°C		80	100	mΩ
		V_{GS}=12V, I_D=20A, T_J=175°C		141		
Gate threshold voltage	$V_{G(th)}$	V_{DS}=5V, I_D=10mA	4	5	6	V
Gate resistance	R_G	f=1MHz, open drain		4.5		Ω

Typical Performance - Reverse Diode

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Diode continuous forward current [1]	I_S	T_C=25°C			31	A
Diode pulse current [2]	$I_{S,pulse}$	T_C=25°C			65	A
Forward voltage	V_{FSD}	V_{GS}=0V, I_F=10A, T_J=25°C		1.5	2	V
		V_{GS}=0V, I_F=10A, T_J=175°C		1.75		
Reverse recovery charge	Q_{rr}	V_R=400V, I_F=20A, V_{GS}=-5V, R_{G_EXT}=10Ω di/dt=2200A/µs, T_J=25°C		119		nC
Reverse recovery time	t_{rr}			16		ns
Reverse recovery charge	Q_{rr}	V_R=400V, I_F=20A, V_{GS}=-5V, R_{G_EXT}=10Ω di/dt=2200A/µs, T_J=150°C		73		nC
Reverse recovery time	t_{rr}			11		ns

Experts on Design-In
Angst+Pfister Sensors and Power

Typical Performance - Dynamic

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Input capacitance	C_{iss}	V_{DS}=100V, V_{GS}=0V f=100kHz		1500		pF
Output capacitance	C_{oss}			104		
Reverse transfer capacitance	C_{rss}			2.6		
Effective output capacitance, energy related	$C_{oss(er)}$	V_{DS}=0V to 400V, V_{GS}=0V		77		pF
Effective output capacitance, time related	$C_{oss(tr)}$	V_{DS}=0V to 400V, V_{GS}=0V		176		pF
C_{OSS} stored energy	E_{oss}	V_{DS}=400V, V_{GS}=0V		6.2		µJ
Total gate charge	Q_G	V_{DS}=400V, I_D=20A, V_{GS} = -5V to 12V		43		nC
Gate-drain charge	Q_{GD}			11		
Gate-source charge	Q_{GS}			19		
Turn-on delay time	$t_{d(on)}$	V_{DS}=400V, I_D=20A, Gate Driver =-5V to +12V, Turn-on $R_{G,EXT}$=8.5Ω, Turn-off $R_{G,EXT}$=20Ω Inductive Load, FWD: same device with V_{GS} = -5V, R_G = 10Ω, T_J=25°C		21		ns
Rise time	t_r			20		
Turn-off delay time	$t_{d(off)}$			37		
Fall time	t_f			8		
Turn-on energy	E_{ON}			121		µJ
Turn-off energy	E_{OFF}			41		
Total switching energy	E_{TOTAL}			162		
Turn-on delay time	$t_{d(on)}$	V_{DS}=400V, I_D=20A, Gate Driver =-5V to +12V, Turn-on $R_{G,EXT}$=8.5Ω, Turn-off $R_{G,EXT}$=20Ω Inductive Load, FWD: same device with V_{GS} = -5V, R_G = 10Ω, T_J=150°C		17		ns
Rise time	t_r			18		
Turn-off delay time	$t_{d(off)}$			36		
Fall time	t_f			7		
Turn-on energy	E_{ON}			107		µJ
Turn-off energy	E_{OFF}			31		
Total switching energy	E_{TOTAL}			138		

Experts on Design-In
Angst+Pfister Sensors and Power

UnitedSiC
Related Devices Buy Online Spice Models Contact Sales Learn More

Typical Performance Diagrams

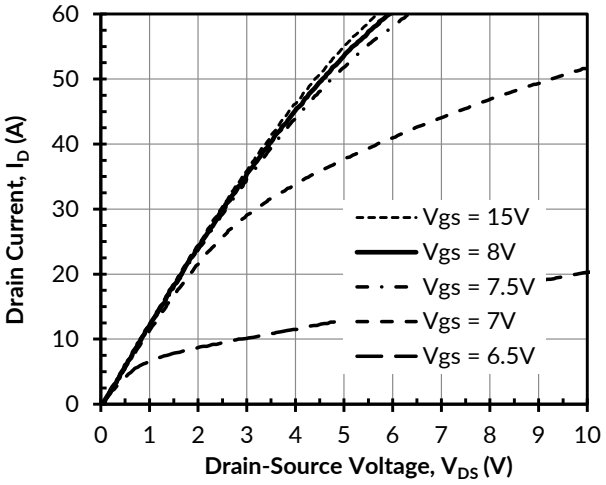


Figure 1. Typical output characteristics at T_J = -55°C, tp < 250µs

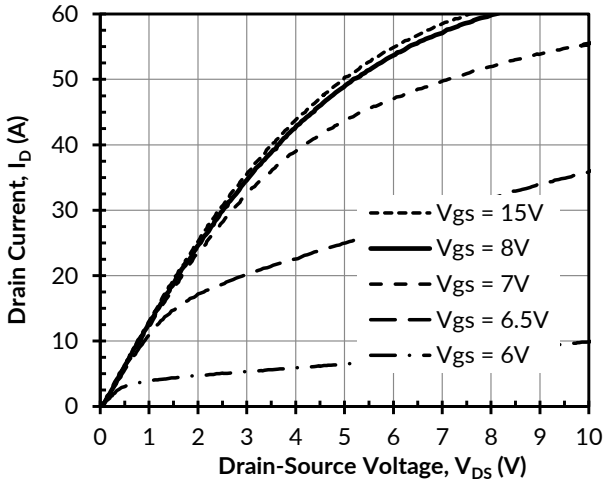


Figure 2. Typical output characteristics at T_J = 25°C, tp < 250µs

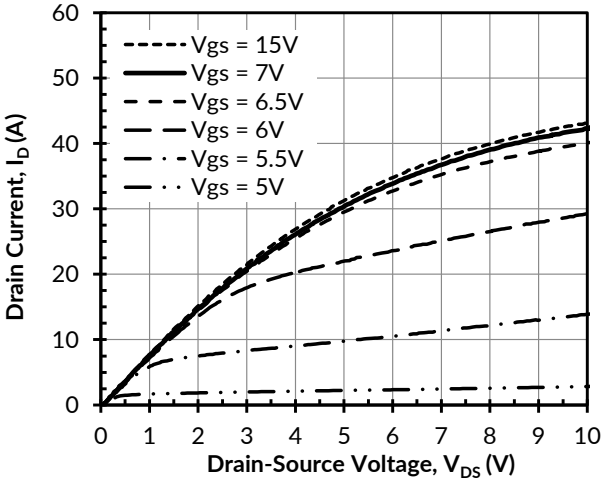


Figure 3. Typical output characteristics at T_J = 175°C, tp < 250µs

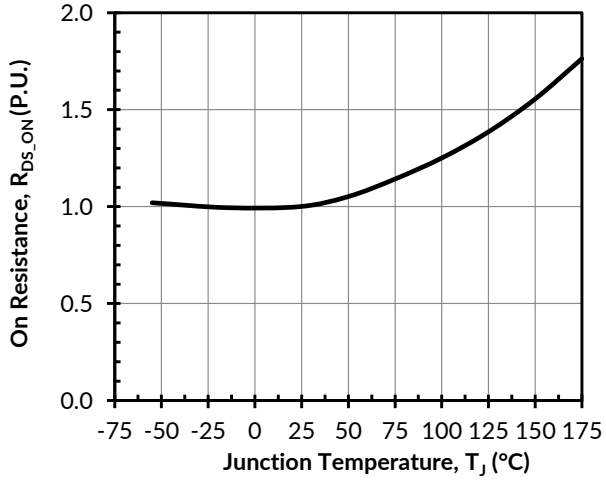


Figure 4. Normalized on-resistance vs. temperature at V_{GS} = 12V and I_D = 20A

Experts on Design-In
Angst+Pfister Sensors and Power

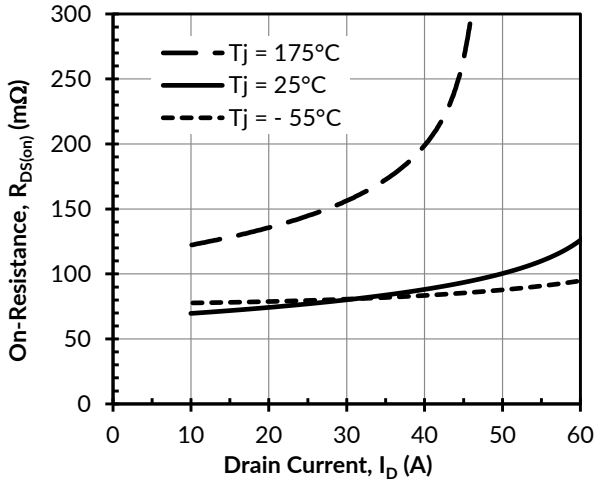


Figure 5. Typical drain-source on-resistances at V_{GS} = 12V

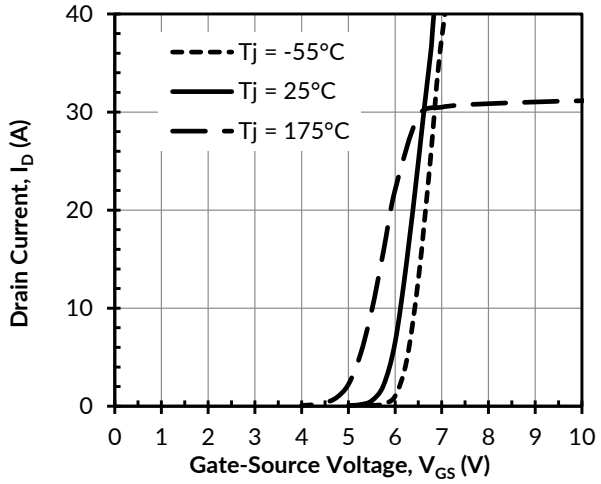


Figure 6. Typical transfer characteristics at V_{DS} = 5V

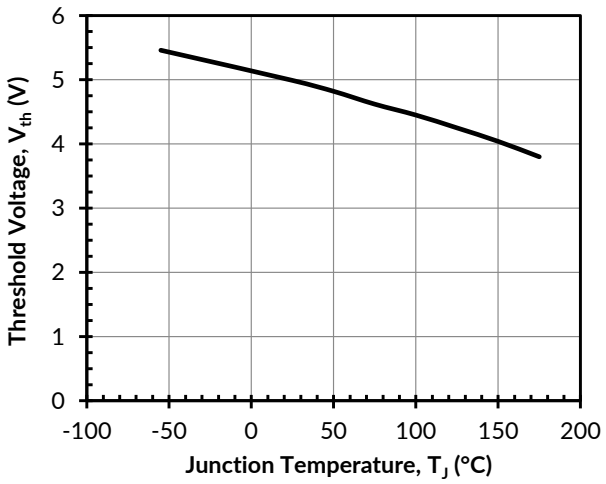


Figure 7. Threshold voltage vs. junction temperature at V_{DS} = 5V and I_D = 10mA

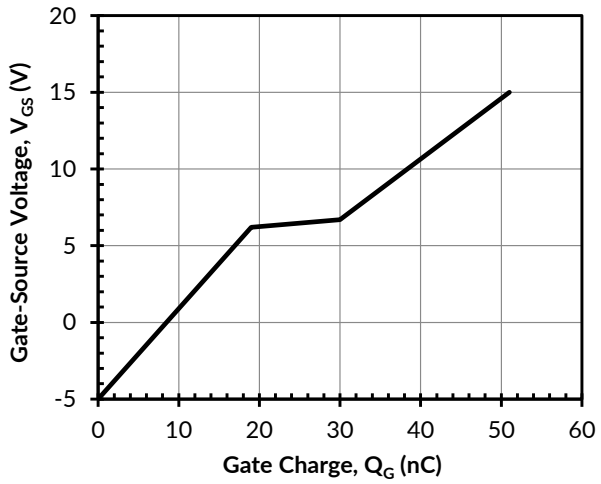


Figure 8. Typical gate charge at V_{DS} = 400V and I_D = 20A

Experts on Design-In
Angst+Pfister Sensors and Power

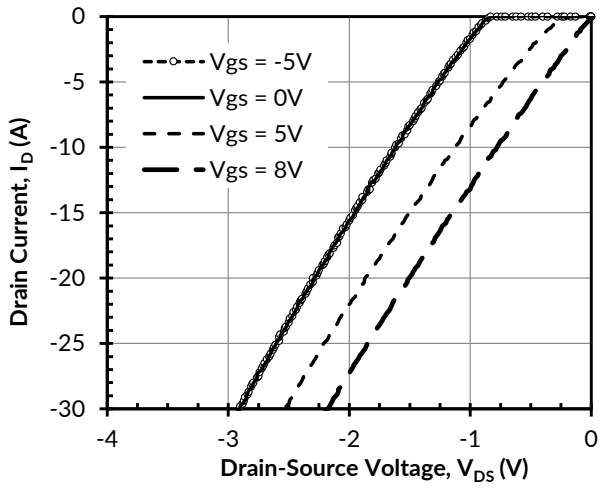


Figure 9. 3rd quadrant characteristics at T_J = -55°C

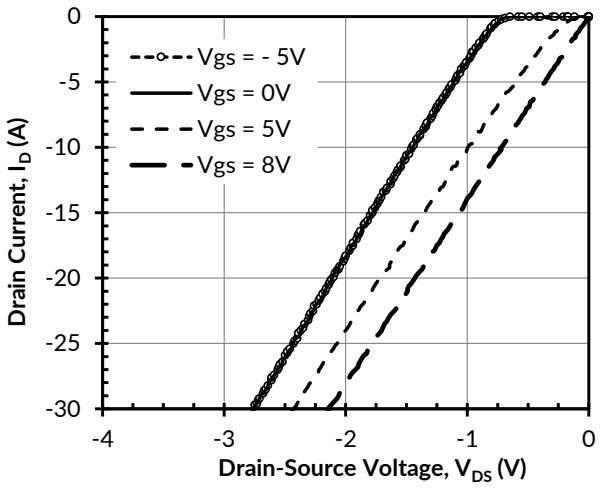


Figure 10. 3rd quadrant characteristics at T_J = 25°C

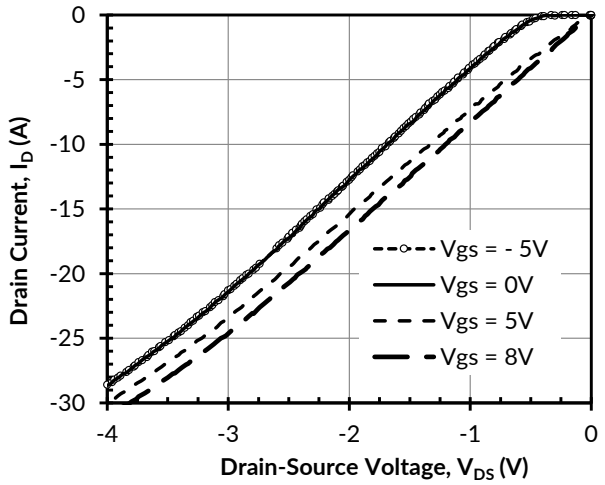


Figure 11. 3rd quadrant characteristics at T_J = 175°C

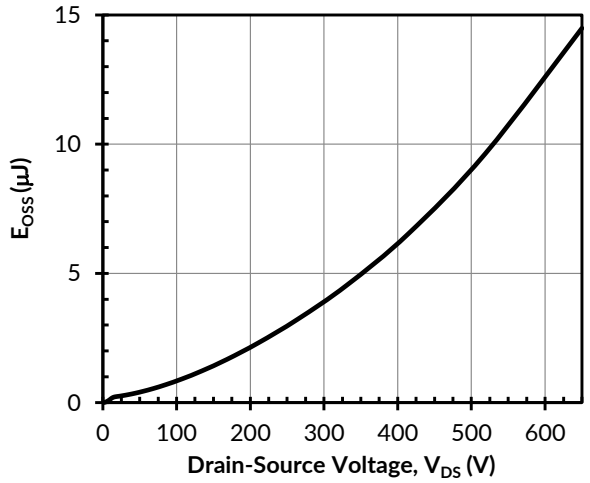


Figure 12. Typical stored energy in C_{OSS} at V_{GS} = 0V

Experts on Design-In
Angst+Pfister Sensors and Power

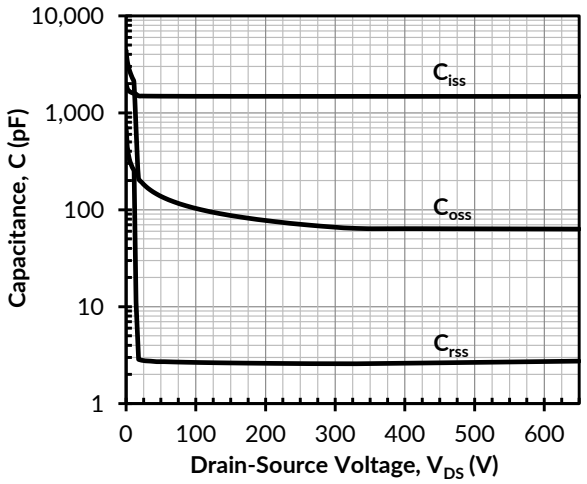


Figure 13. Typical capacitances at f = 100kHz and V_{GS} = 0V

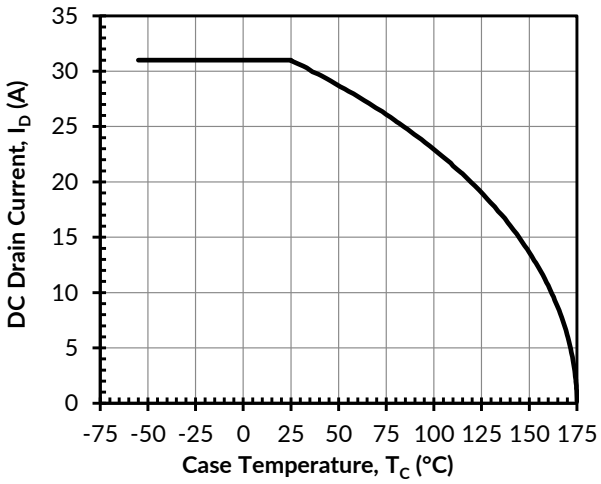


Figure 14. DC drain current derating

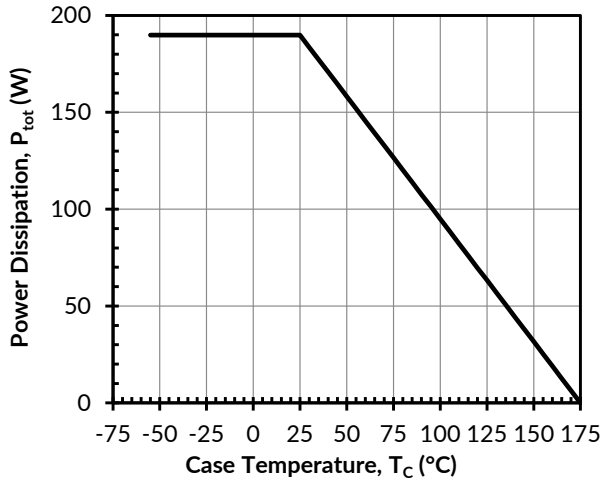


Figure 15. Total power dissipation

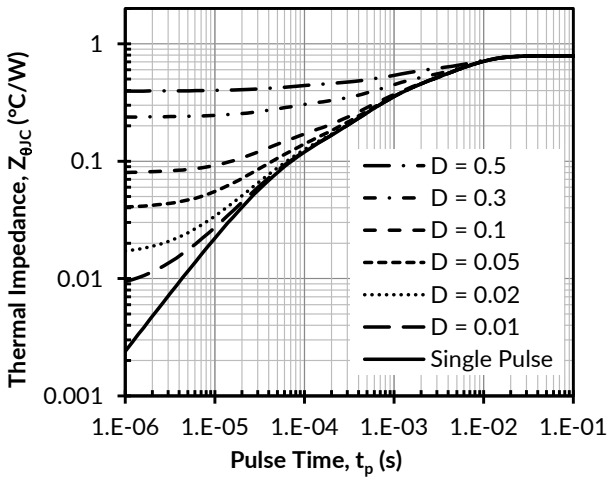


Figure 16. Maximum transient thermal impedance

Experts on Design-In
Angst+Pfister Sensors and Power

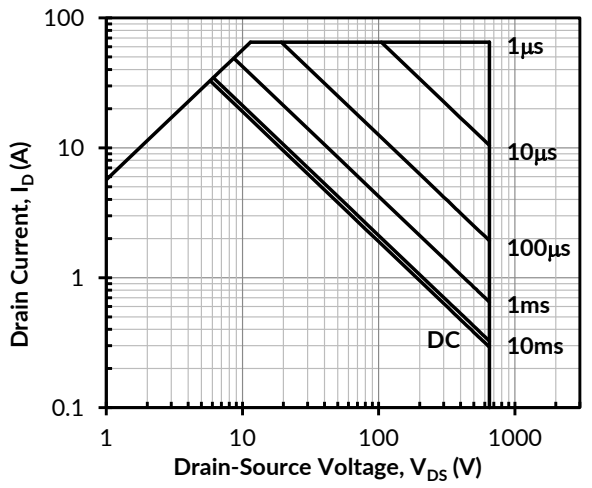


Figure 17. Safe operation area at T_C = 25°C, D = 0, Parameter t_p

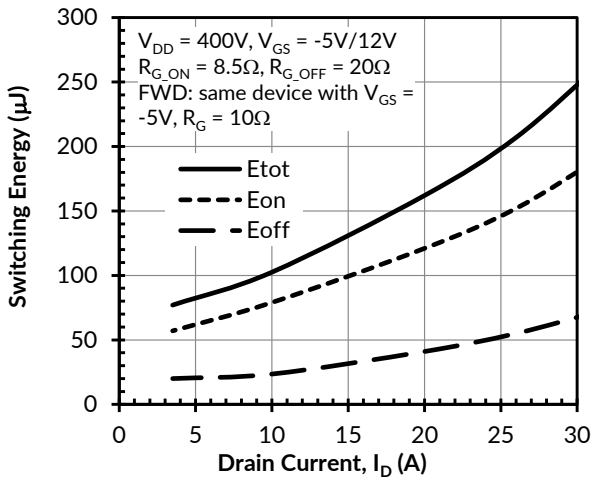


Figure 18. Clamped inductive switching energy vs. drain current at T_J = 25°C

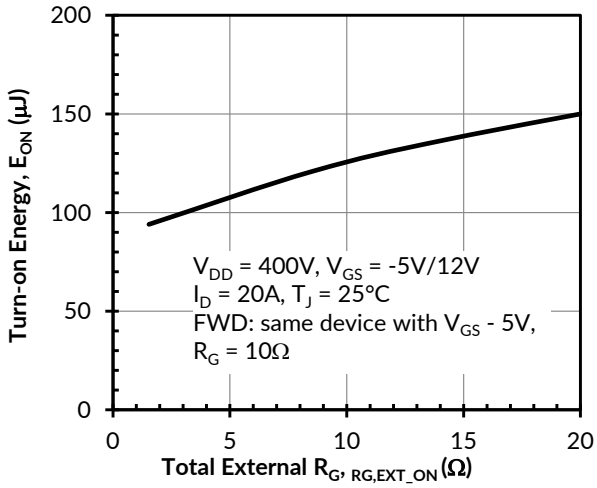


Figure 19. Clamped inductive switching turn-on energy vs. R_{G,EXT_ON}

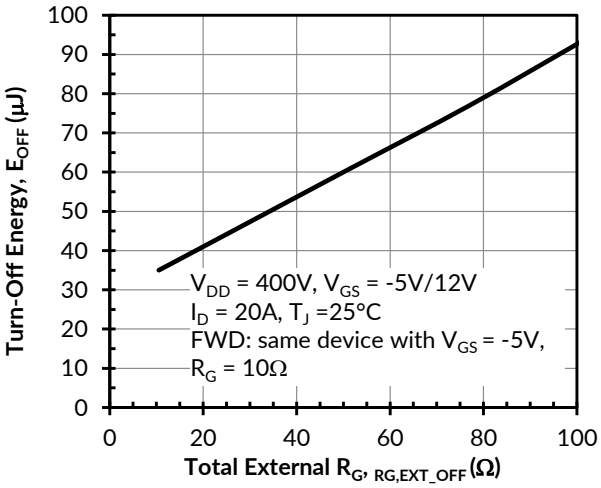


Figure 20. Clamped inductive switching turn-off energy vs. R_{G,EXT_OFF}

Experts on Design-In
Angst+Pfister Sensors and Power

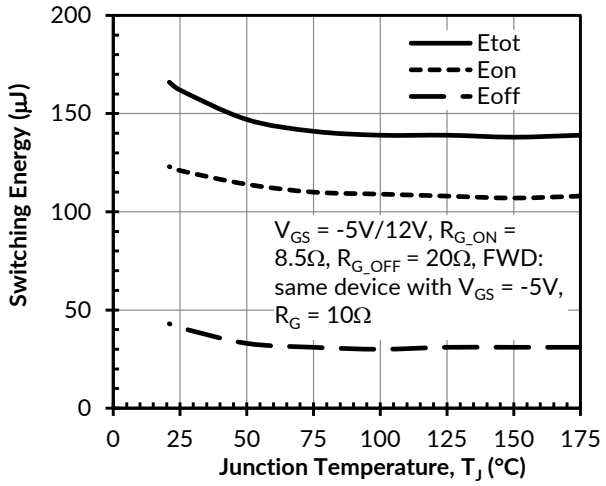


Figure 21. Clamped inductive switching energy vs. junction temperature at V_{DS} = 400V and I_D = 20A

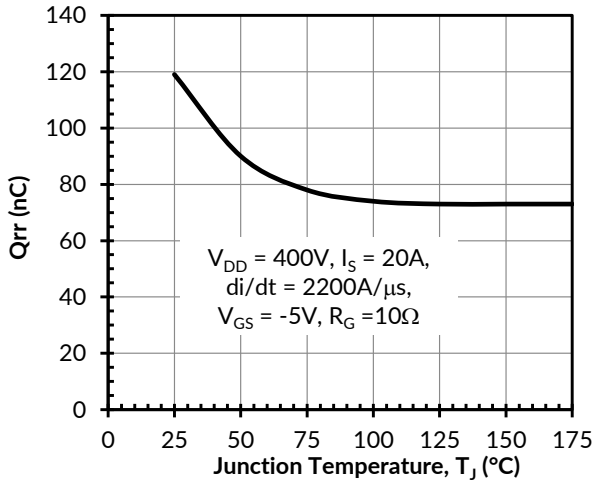


Figure 22. Reverse recovery charge Qrr vs. junction temperature

Applications Information

SiC cascodes are enhancement-mode power switches formed by a high-voltage SiC depletion-mode JFET and a low-voltage silicon MOSFET connected in series. The silicon MOSFET serves as the control unit while the SiC JFET provides high voltage blocking in the off state. This combination of devices in a single package provides compatibility with standard gate drivers and offers superior performance in terms of low on-resistance ($R_{DS(on)}$), output capacitance (C_{oss}), gate charge (Q_G), and reverse recovery charge (Qrr) leading to low conduction and switching losses. The SiC cascodes also provide excellent reverse conduction capability eliminating the need for an external anti-parallel diode.

Like other high performance power switches, proper PCB layout design to minimize circuit parasitics is strongly recommended due to the high dv/dt and di/dt rates. An external gate resistor is recommended when the cascode is working in the diode mode in order to achieve the optimum reverse recovery performance. For more information on cascode operation, see www.unitedsic.com.

Disclaimer

United Silicon Carbide, Inc. reserves the right to change or modify any of the products and their inherent physical and technical specifications without prior notice. United Silicon Carbide, Inc. assumes no responsibility or liability for any errors or inaccuracies within.

Information on all products and contained herein is intended for description only. No license, express or implied, to any intellectual property rights is granted within this document.

United Silicon Carbide, Inc. assumes no liability whatsoever relating to the choice, selection or use of the United Silicon Carbide, Inc. products and services described herein.

Experts on Design-In
Angst+Pfister Sensors and Power

Angst+Pfister
Sensors and Power

We are here for you. Addresses and Contacts.

Headquarter Switzerland:

Angst+Pfister Sensors and Power AG
Thurgauerstrasse 66
CH-8050 Zurich
Phone +41 44 877 35 00
sensorsandpower@angst-pfister.com

Office Germany:

Angst+Pfister Sensors and Power Deutschland GmbH
Edisonstraße 16
D-85716 Unterschleißheim
Phone +49 89 374 288 87 00
sensorsandpower.de@angst-pfister.com

Scan here and get an overview of personal contacts!

sensorsandpower.angst-pfister.com